

Full Color PCB Type SMD LED VAOL-S2223RGB

Features

- Package in 8mm tape on a 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- RoHS compliant version.



- The SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density and reduced storage space and finally smaller equipment to be obtained.
- Light weigh makes them ideal for miniature applications.



Device Selection Guide

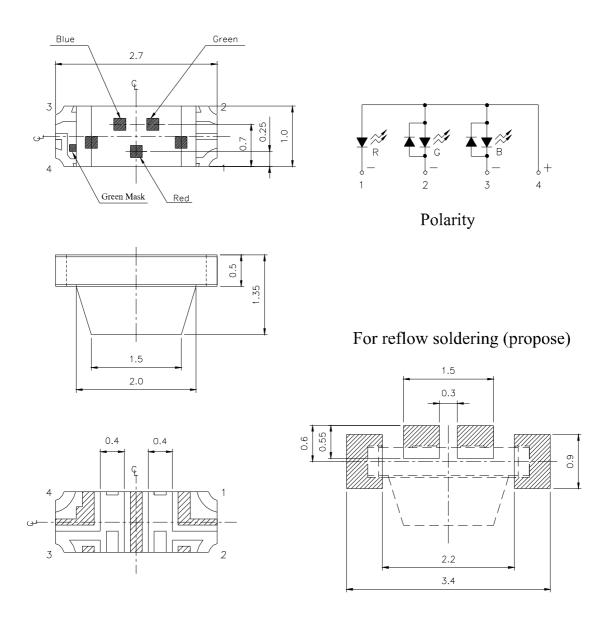
Туре	Material	Emitted Color	Lens Color		
R6	AlInGaN	Brilliant Red			
GH	InGaN	Brilliant Green	Water Clear		
ВН	InGaN	Blue			







Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm







Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	Vr	5	V	
	IF	R6:25		
Forward Current		GH:25	mA	
		BH:25		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
	Pd	R6:60		
Power Dissipation		GH:110	mW	
		BH:110		
Daal- Farmand Comment	IFP	R6:60		
Peak Forward Current		GH:100	mA	
(Duty 1/10 @1KHz)		BH:100		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec Hand Soldering: 350 °C for 3 sec.		

Specific binning requirements- please contact our home office







Electro-Optical Characteristics (Ta=25°C)

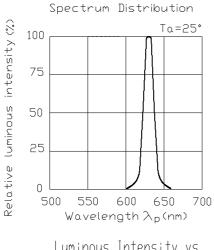
Parameter	Syr	nbol	Min.	Тур.	Max.	Unit	Condition
		R6	45	72			
Luminous Intensity	Iv	GH	112	180		mcd	I _F =20mA
		ВН	28.5	45			
Viewing Angle θ	2	1/2		120		deg	I _F =20mA
		R6		632			
Peak Wavelength	λр	GH		518		nm	I _F =20mA
		ВН		468			
		R6	615		630		
Dominant Wavelength	λd	GH	510		540	nm	I _F =20mA
		ВН	460		480		
		R6		20			
Spectrum Radiation Bandwidth	Δλ	GH		35		nm	I _F =20mA
		ВН		35			
		R6	1.7	2.0	2.4		
Forward Voltage	VF	GH	2.7	3.3	3.7	V	I _F =20mA
		ВН	2.7	3.3	3.7		
		R6			10		
Reverse Current	Ir	GH			50	μ A	$V_R=5V$
		ВН			50		

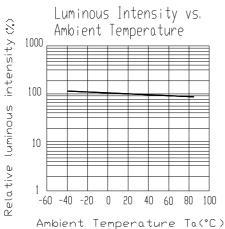


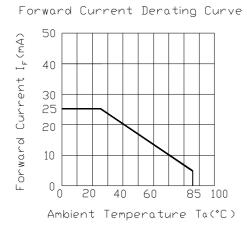


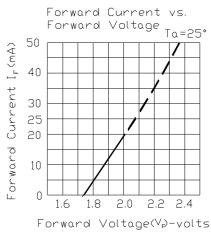
Typical Electro-Optical Characteristics Curves

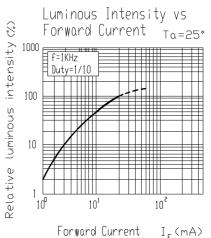
R6

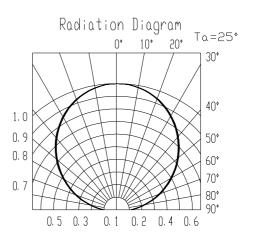










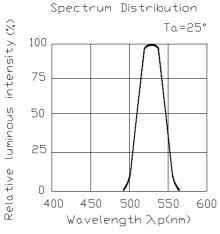


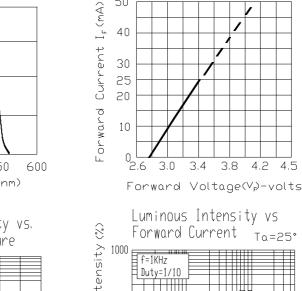




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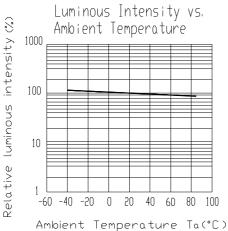
GH

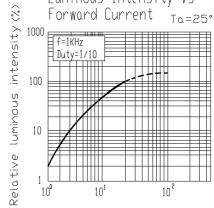




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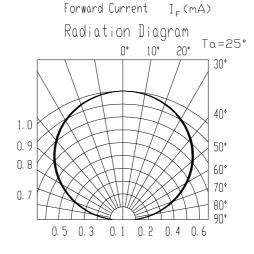


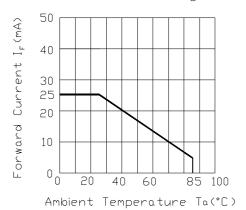
Forward Current vs. Forward Voltage

Ta=25°

4.2







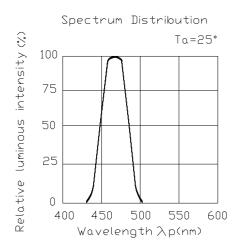


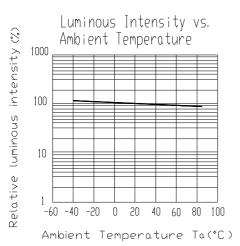


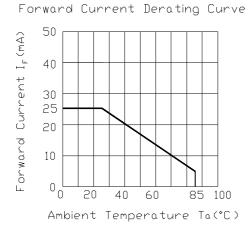


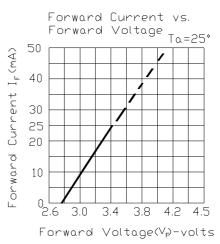
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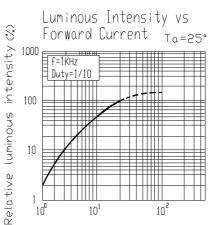
BH

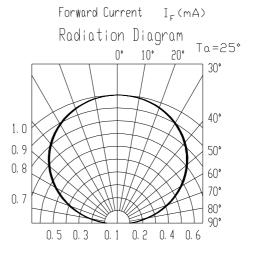








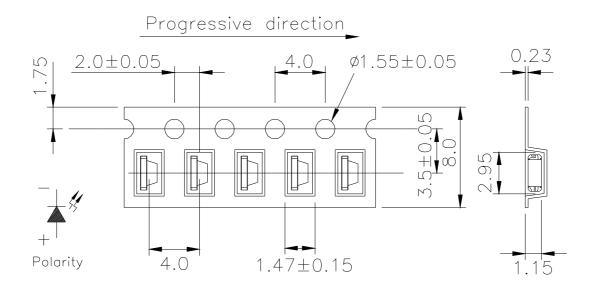






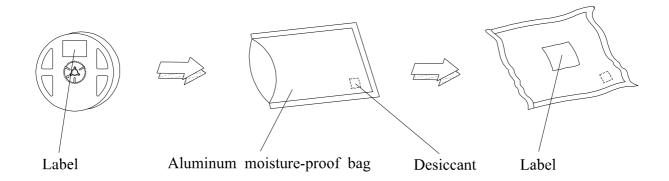


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging









Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1





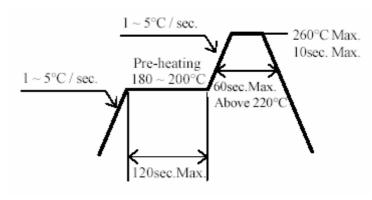
Precautions For Use

1. Customer must apply resistors for protection, otherwise a slight voltage shift will cause a big current change.

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.





Mouser Electronics

Authorized Distributor

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VCC:

VAOL-S2223RGB